U.S. PTO 12/586022

09/16/2009 Form PTO-1595 (Rev. 09/ 04) IMERCE 09-30-2009 OMB No. 0651-0027 (exp. 6/30/2005) rk Office RECORDATION FORM COV PATENTS ON 103575636 To the Director of the U.S. Patent and Trademark Office: Please record th elow 1. Name of conveying party(ies)/Execution Date(s): 2. Name and address of receiving party(ies) MASAKI KITANO (07/31/2009) AND HIDEKAZU KIKUCHI (08/04/2009) SONY CORPORATION Internal Address: Execution Date(s): in parentheses after inventor name Street Address: X No Additional name(s) of conveying party(les) attached? 1-7-1 Konan, Minato-ku Tokyo 108-0075 3. Nature of Conveyance: **JAPAN** x Assignment Merger Security Agreement Change of Name City: _ Government Interest Assignment State: Executive Order 9424, Confirmatory License Country: Zip: Additional name(s) & address(es) Yes X No attached: x This document is being filed together with a new application. 4. Application or patent number(s): A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached? 5. Name and address to whom correspondence 6. Total number of applications and concerning document should be mailed: patents involved: Name: Dennis M. Smid, Esq. LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP 7. Total fee (37 CFR 1.21(h) & 3.41) 40.00 Internal Address: Atty. Dkt.: SONYJP 3.0-2001 Authorized to be charged by credit card Street Address: 600 South Avenue West Authorized to be charged to deposit account Enclosed None required (government interest not affecting title) Westfield City: 8. Payment Information 07090 State: Zip: a. Credit Card Last 4 Numbers 69/29/26**09×DEXIMO C/86**000033 12586022 (908) 518-6374 Phone Number: 121095 Fax Number: (908) 654-0415 b. Deposit@cppy@agatumber Email Address: dsmid@idlkm.com Authorized User Name Dennis M. Smid, Esq. 9. Signature:

Dennis M. Smid, Esq. - 34,930

Name of Person Signing

September 16, 2009

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Total number of pages including cover

sheet, attachments, and documents:

Attorney Docket No. SONYJP 3.0-2001 SONY Ref. No.: SO9P1546US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in VIDEO DISPLAY DEVICE, METHOD OF DISPLAYING CONNECTORS, TRANSMISSION-LINE STATE DETECTION DEVICE,

TRANSMISSION LINE-STATE DETECTION METHOD AND SEMICONDUCTOR INTEGRATED CIRCUIT

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

	n this application to insert the serial number and filing date of this application is, Filing Date:
This assignment executed on the dates indicated below.	•
MASAKI KITANO	July 31, 2009
Name of first or sole inventor TOKYO JAPAN	Execution date of U.S. Patent Application
Residence of First or sole inventor	July 31, 2009
Signature of first or sole inventor	Date of this assignment
HIDEKAZU KIKUCHI Name of second inventor KANAGAWA JAPAN	Aug. 4, 2009 Execution date of U.S. Patent Application
Residence of second inventor Hickory Kikuchi	Aug. 4, 2009.
Signature of accord inventor	Date of this assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	

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PATENT REEL: 023302 FRAME: 0902